



OPA4243



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Quad OPERATIONAL AMPLIFIER *MicroPOWER, Single-Supply*

FEATURES

- MICRO-SIZE, TSSOP PACKAGE
- SINGLE-SUPPLY OPERATION
- WIDE SUPPLY RANGE: 2.2V to 36V
- LOW QUIESCENT CURRENT: 45 μ A/chan
- WIDE BANDWIDTH: 430kHz
- WIDE INPUT/OUTPUT SWING

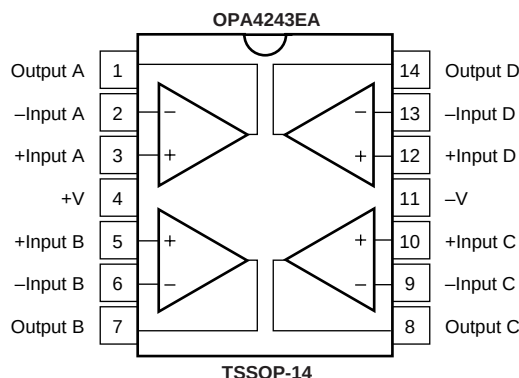
APPLICATIONS

- LCD DISPLAY DRIVERS
- BATTERY POWERED SYSTEMS
- PORTABLE EQUIPMENT
- PCMCIA CARDS
- BATTERY PACKS AND POWER SUPPLIES
- CONSUMER PRODUCTS

DESCRIPTION

The OPA4243 is a four-channel op amp specifically designed for high density, space-limited applications, such as LCD bias drivers, PCMCIA cards, battery-packs and portable instruments. In addition to small size, this part features wide output swing, very low quiescent current, and low bias current. Other features include unity gain stability and the best speed power ratio available. Power supplies in the range of 2.2V to 36V ($\pm 1.1V$ to $\pm 18V$) can be used.

Each channel uses completely independent circuitry for lowest crosstalk and freedom from interaction, even when overloaded. In addition, the amplifier is free from output inversion when the inputs are driven to the rail. The OPA4243EA is supplied in the miniature TSSOP-14 surface mount package. Specifications apply from -40°C to $+85^{\circ}\text{C}$. However, as the extensive typical performance curves indicate, the OPA4243 can be used over the full -55°C to $+125^{\circ}\text{C}$ range. A SPICE macromodel is available for design analysis.



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Twx: 910-952-1111 • Internet: <http://www.burr-brown.com/> • Cable: BBRCORP • Telex: 066-6491 • FAX: (520) 889-1510 • Immediate Product Info: (800) 548-6132

SPECIFICATIONS: $V_S = +2.6V$ to $+36V$

Boldface limits apply over the specified temperature range, $T_A = -40^{\circ}C$ to $+85^{\circ}C$

At $T_A = +25^{\circ}C$, $R_L = 20k\Omega$ connected to ground, unless otherwise noted.

PARAMETER	CONDITIONS	OPA4243EA			UNITS
		MIN	TYP ⁽¹⁾	MAX	
OFFSET VOLTAGE					
Input Offset Voltage V_{OS}	$V_S = \pm 7.5V$, $V_{CM} = 0$		± 2	± 5	mV
Over Temperature				± 6	mV
vs Temperature dV_{OS}/dT	$T_A = -40^{\circ}C$ to $+85^{\circ}C$		± 2.5		$\mu V/^{\circ}C$
vs Power Supply PSRR	$V_S = +2.6V$ to $+36V$		2.5	100	$\mu V/V$
Over Temperature	$V_S = +2.6V$ to $+36V$			100	$\mu V/V$
Channel Separation			140		dB
INPUT BIAS CURRENT					
Input Bias Current I_R	$V_{CM} = V_S/2$		-10	-25	nA
Input Offset Current I_{OS}	$V_{CM} = V_S/2$		± 1	± 10	nA
NOISE					
Input Noise Voltage, $f = 0.1$ to $10Hz$			0.4		$\mu Vp-p$
Input Noise Voltage Density, $f = 1kHz$ e_n			22		$nV/\sqrt{Hz}$
Current Noise Density, $f = 1kHz$ i_n			40		$fA/\sqrt{Hz}$
INPUT VOLTAGE RANGE					
Common-Mode Voltage Range V_{CM}	$V_S = \pm 18V$, $V_{CM} = -18V$ to $+17.1V$	0		$(V+) - 0.9$	V
Common-Mode Rejection $CMRR$	$V_S = \pm 18V$, $V_{CM} = -18V$ to $+17.1V$	82	104		dB
Over Temperature		82			dB
INPUT IMPEDANCE					
Differential			$10^6 \parallel 2$		$\Omega \parallel pF$
Common-Mode			$10^9 \parallel 2$		$\Omega \parallel pF$
OPEN-LOOP GAIN					
Open-Loop Voltage Gain A_{OL}	$V_O = 0.5V$ to $(V+) - 0.9$	86	104		dB
Over Temperature	$V_O = 0.5V$ to $(V+) - 0.9$	86			dB
FREQUENCY RESPONSE					
Gain-Bandwidth Product GBW	$G = 1$		430		kHz
Slew Rate SR	10V Step		-0.1, ± 0.16		V/ μs
Setting Time, 0.01%	$V_{IN} \bullet \text{Gain} = V_S$		150		μs
Overload Recovery Time			8		μs
OUTPUT					
Voltage Output, Positive V_O	$A_{OL} \geq 80dB$, $R_L = 20k\Omega$ to $V_S/2$	$(V+) - 0.9$	$(V+) - 0.75$		V
Over Temperature	$A_{OL} \geq 80dB$, $R_L = 20k\Omega$ to $V_S/2$	$(V+) - 0.9$	$(V+) - 0.75$		V
Voltage Output, Negative	$A_{OL} \geq 80dB$, $R_L = 20k\Omega$ to $V_S/2$	0.5	0.2		V
Over Temperature	$A_{OL} \geq 80dB$, $R_L = 20k\Omega$ to $V_S/2$	0.5	0.2		V
Voltage Output, Positive	$A_{OL} \geq 80dB$, $R_L = 20k\Omega$ to Ground		$(V+) - 0.75$		V
Over Temperature	$A_{OL} \geq 80dB$, $R_L = 20k\Omega$ to Ground		$(V+) - 0.75$		V
Voltage Output, Negative	$A_{OL} \geq 80dB$, $R_L = 20k\Omega$ to Ground		0.1		V
Over Temperature	$A_{OL} \geq 80dB$, $R_L = 20k\Omega$ to Ground		0.1		V
Short-Circuit Current I_{SC}			-25, +12		mA
Capacitive Load Drive C_{LOAD}			See Typical Curve		
POWER SUPPLY					
Specified Voltage Range V_S	Over Temperature	+2.6		+36	V
Minimum Operating Voltage			+2.2		V
Quiescent Current I_O	$I_O = 0$		45	60	μA
Over Temperature	$I_O = 0$			70	μA
TEMPERATURE RANGE					
Specified Range		-40		85	$^{\circ}C$
Operating Range		-55		125	$^{\circ}C$
Storage Range		-65		150	$^{\circ}C$
Thermal Resistance θ_{JA}					
TSSOP-14 Surface Mount			100		$^{\circ}C/W$

NOTE: (1) $V_S = +15V$.

ABSOLUTE MAXIMUM RATINGS⁽¹⁾

Supply Voltage, V+ to V–	36V
Input Voltage Range ⁽²⁾	(V–) – 0.3V to (V+) + 0.3V
Input Current ⁽²⁾	10mA
Output Short-Circuit ⁽³⁾	Continuous
Operating Temperature	–55°C to +125°C
Storage Temperature	–65°C to +150°C
Junction Temperature	150°C
Lead Temperature (soldering, 10s)	300°C
ESD Capability	2000V

NOTES: (1) Stresses above these ratings may cause permanent damage. Exposure to absolute maximum conditions for extended periods may degrade device reliability. (2) Inputs are diode-clamped to the supply rails and should be current-limited to 10mA or less if input voltages can exceed rails by more than 0.3V. (3) Short-circuit to ground, one amplifier per package.



ELECTROSTATIC DISCHARGE SENSITIVITY

This integrated circuit can be damaged by ESD. Burr-Brown recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

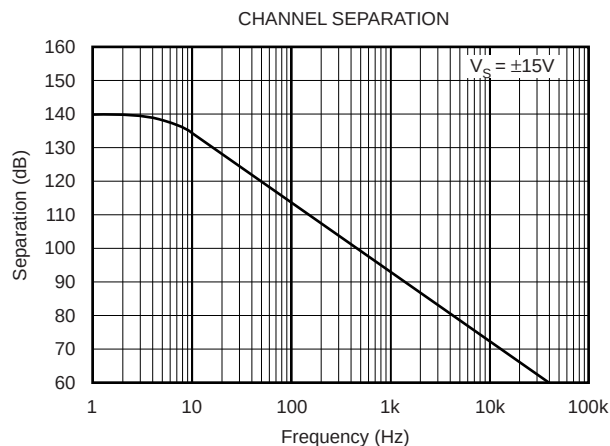
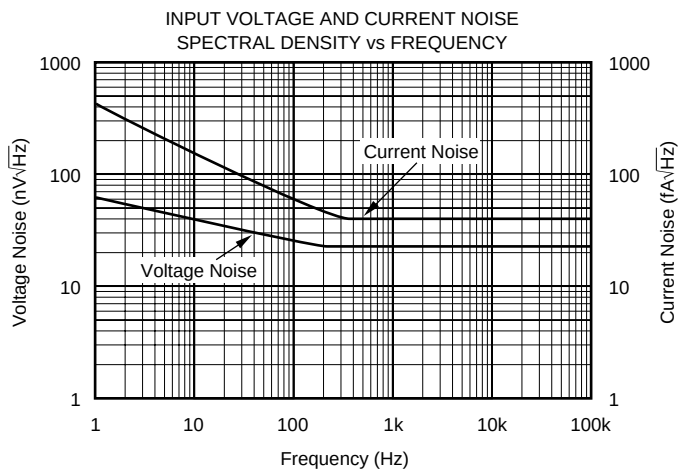
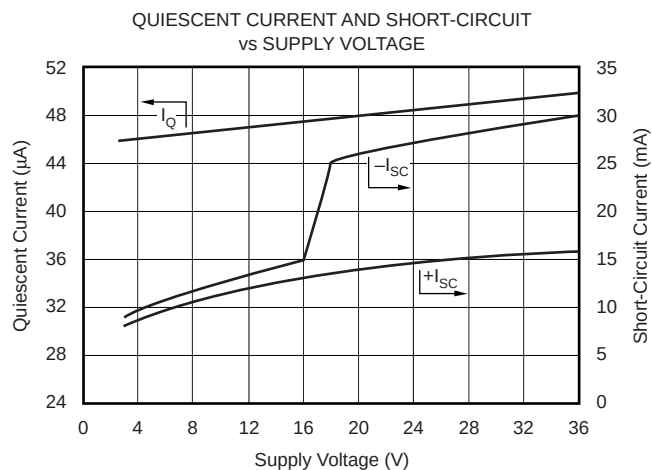
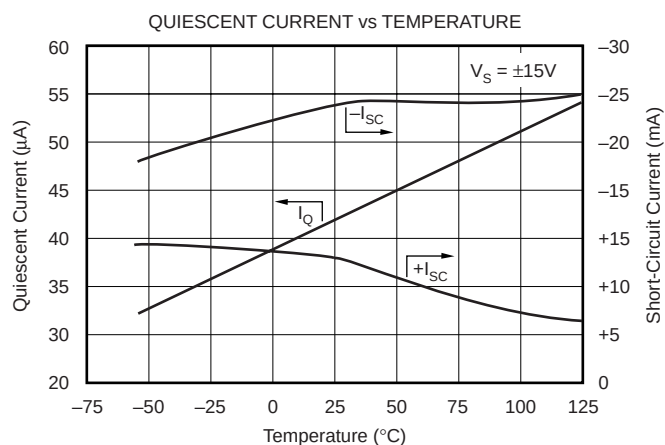
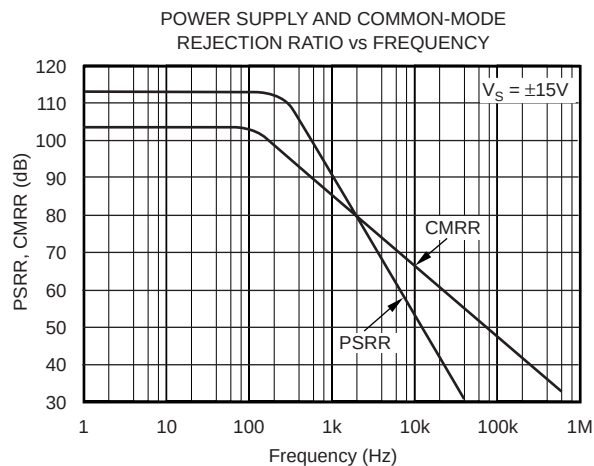
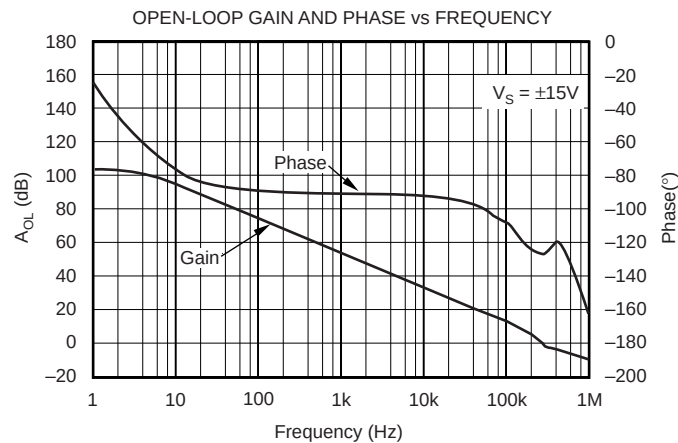
PACKAGE/ORDERING INFORMATION

PRODUCT	PACKAGE	PACKAGE DRAWING NUMBER	SPECIFIED TEMPERATURE RANGE	PACKAGE MARKING	ORDERING NUMBER ⁽¹⁾	TRANSPORT MEDIA
OPA4243EA "	TSSOP-14 "	357 "	–40°C to +85°C "	OPA4243EA "	OPA4243EA/250 OPA4243EA/2K5	Tape and Reel Tape and Reel

NOTE: (1) Models with a slash (/) are available only in Tape and Reel in the quantities indicated (e.g., /2K5 indicates 2500 devices per reel). Ordering 2500 pieces of "OPA4243EA" will get a single 2500-piece Tape and Reel.

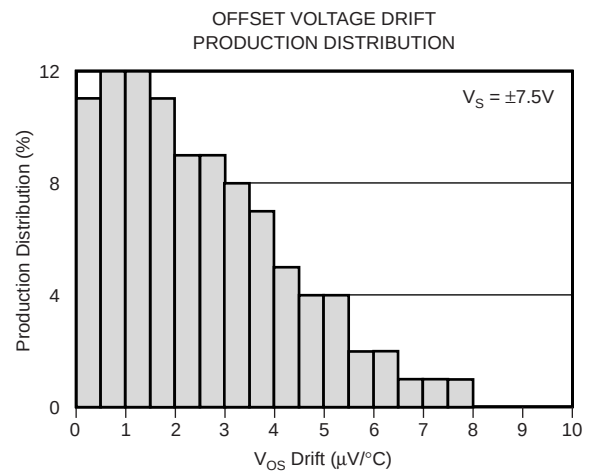
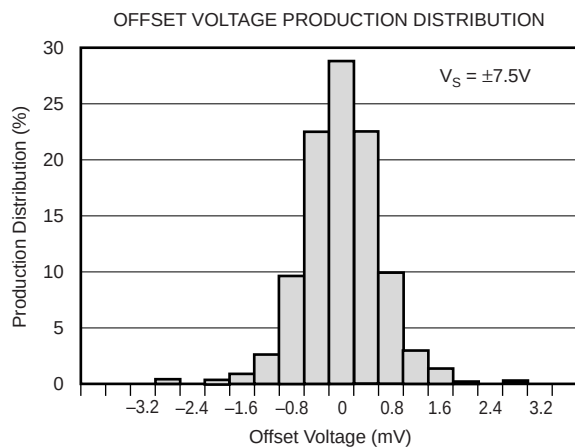
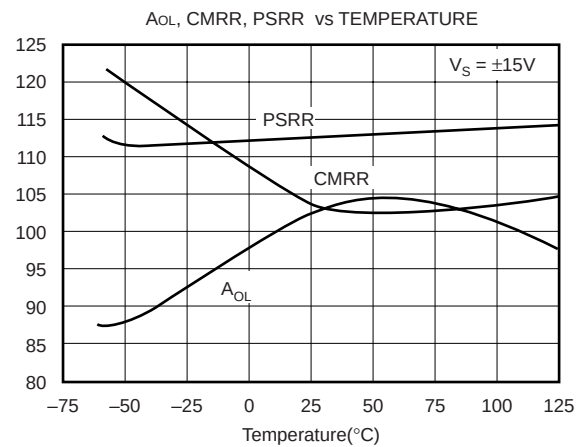
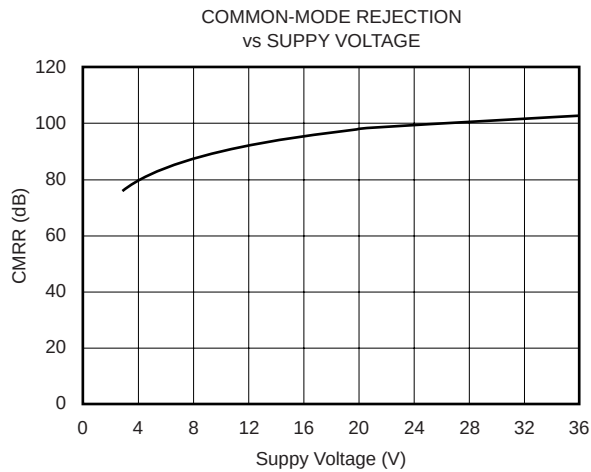
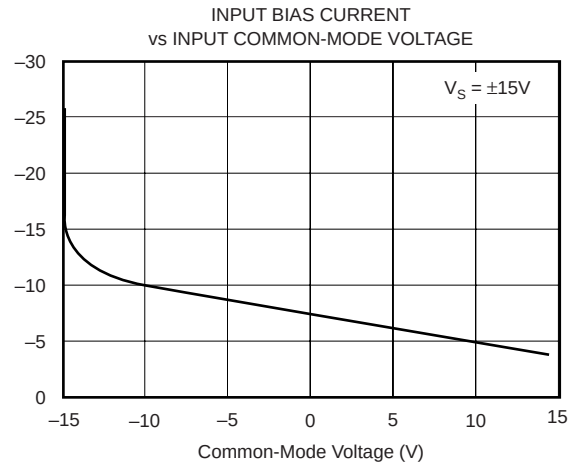
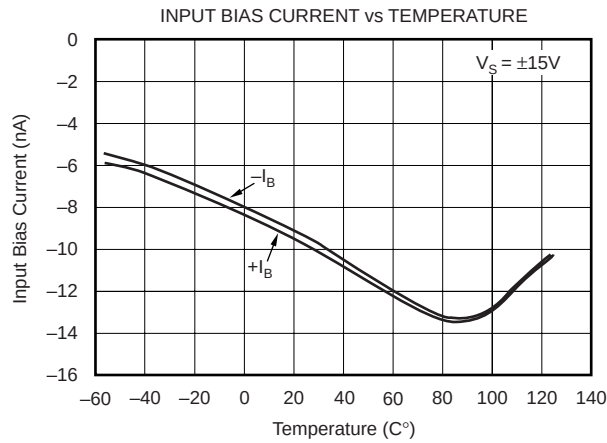
TYPICAL PERFORMANCE CURVES

At $T_A = +25^\circ\text{C}$, $R_L = 20\text{k}\Omega$ connected to ground, unless otherwise noted.



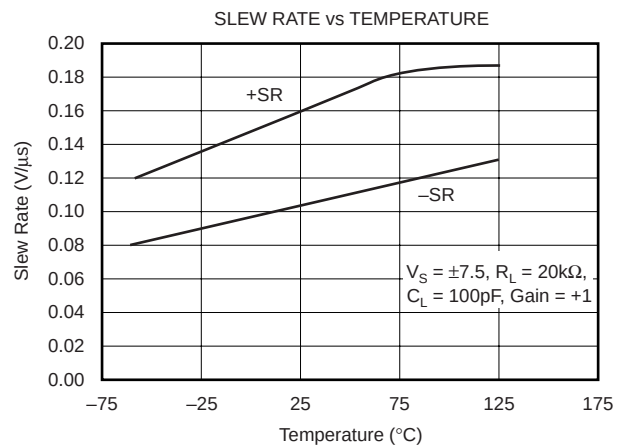
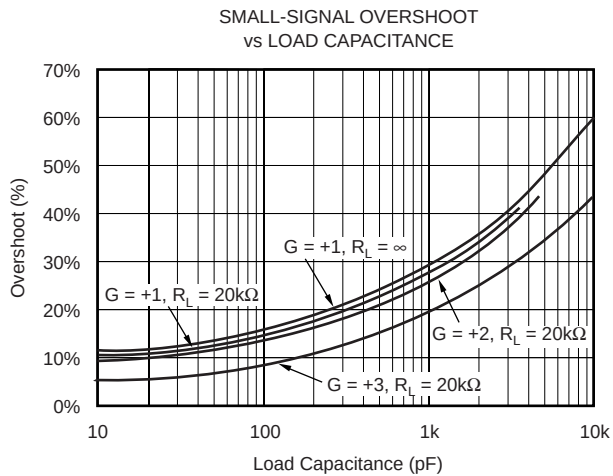
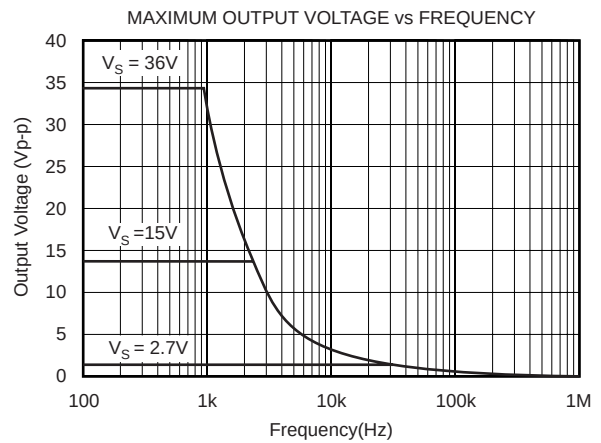
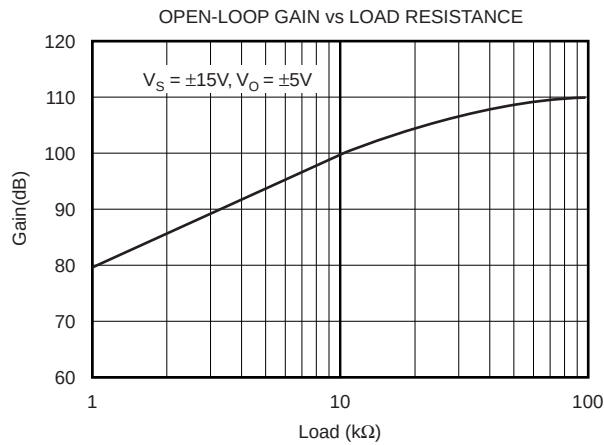
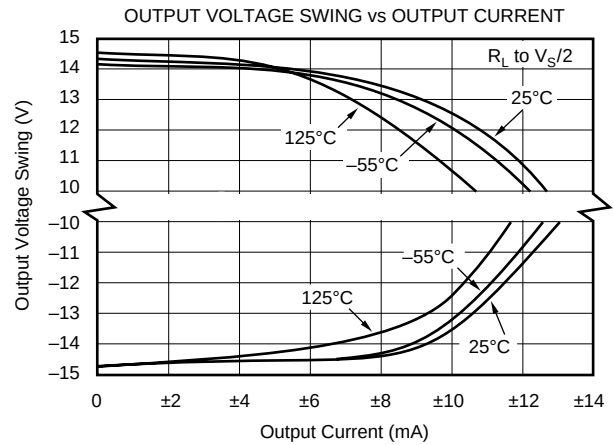
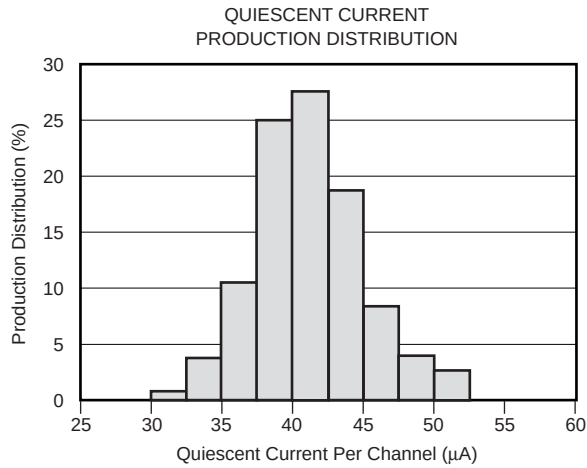
TYPICAL PERFORMANCE CURVES (Cont.)

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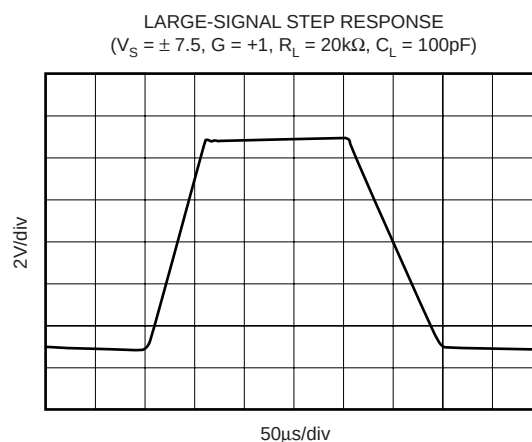
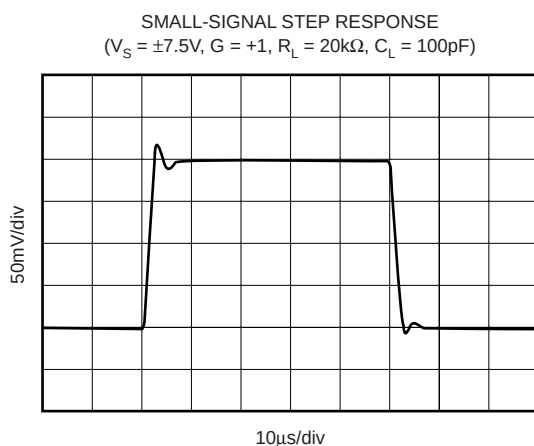
TYPICAL PERFORMANCE CURVES (Cont.)

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TYPICAL PERFORMANCE CURVES (Cont.)

At $T_A = +25^\circ\text{C}$, $R_L = 20\text{k}\Omega$ connected to ground, unless otherwise noted.



APPLICATION INFORMATION

The OPA4243 is unity-gain stable and suitable for a wide range of general-purpose applications. The power supply pins should be bypassed with $0.01\mu\text{F}$ ceramic capacitors.

OPERATING VOLTAGE

The OPA4243 can operate from single supply (2.2V to 36V) or dual supplies ($\pm 1.1\text{V}$ to $\pm 18\text{V}$) with excellent performance. Unlike most op amps which are specified at only one supply voltage, the OPA4243 is specified for real world applications; a single set of specifications applies throughout the 2.6V to 36V supply range. This allows the designer to have the same assured performance at any supply voltage within this range.

In addition, many key parameters are guaranteed over the specified temperature range, -40°C to $+85^\circ\text{C}$. Most behaviors remain unchanged throughout the full operating voltage range. Parameters, which vary significantly with operating voltage or temperature, are shown in the typical performance curves.

PRINTED CIRCUIT BOARD LAYOUT

See Burr-Brown Application Note AB-132 for specific PC board layout recommendations.

INPUT PROTECTION

Rail-to-rail input signals will not cause damage or invert the output of the OPA4243. To protect against ESD and excessive input voltage (beyond the supply rails) the OPA4243 includes diodes from the input terminals to the power supply rails. Normally, these diodes are reversed biased and have negligible effect on circuit operation. However, if the input voltage is allowed to exceed the supply voltages by enough to forward bias these diodes (generally, 0.3V to 0.6V) excessive input current could flow. If this condition could occur (for example, if an input signal is applied when the op amp supply voltage is zero), care should be taken to limit the input current to less than 10mA to avoid damage. An input signal beyond the supplies, with power applied, can cause an unexpected output inversion.

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish	MSL Peak Temp (3)	Op Temp (°C)	Top-Side Markings (4)	Samples
OPA4243EA/250	ACTIVE	TSSOP	PW	14	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR		OPA 4243EA	Samples
OPA4243EA/250E4	ACTIVE	TSSOP	PW	14	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR		OPA 4243EA	Samples
OPA4243EA/2K5	ACTIVE	TSSOP	PW	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR		OPA 4243EA	Samples
OPA4243EA/2K5E4	ACTIVE	TSSOP	PW	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR		OPA 4243EA	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

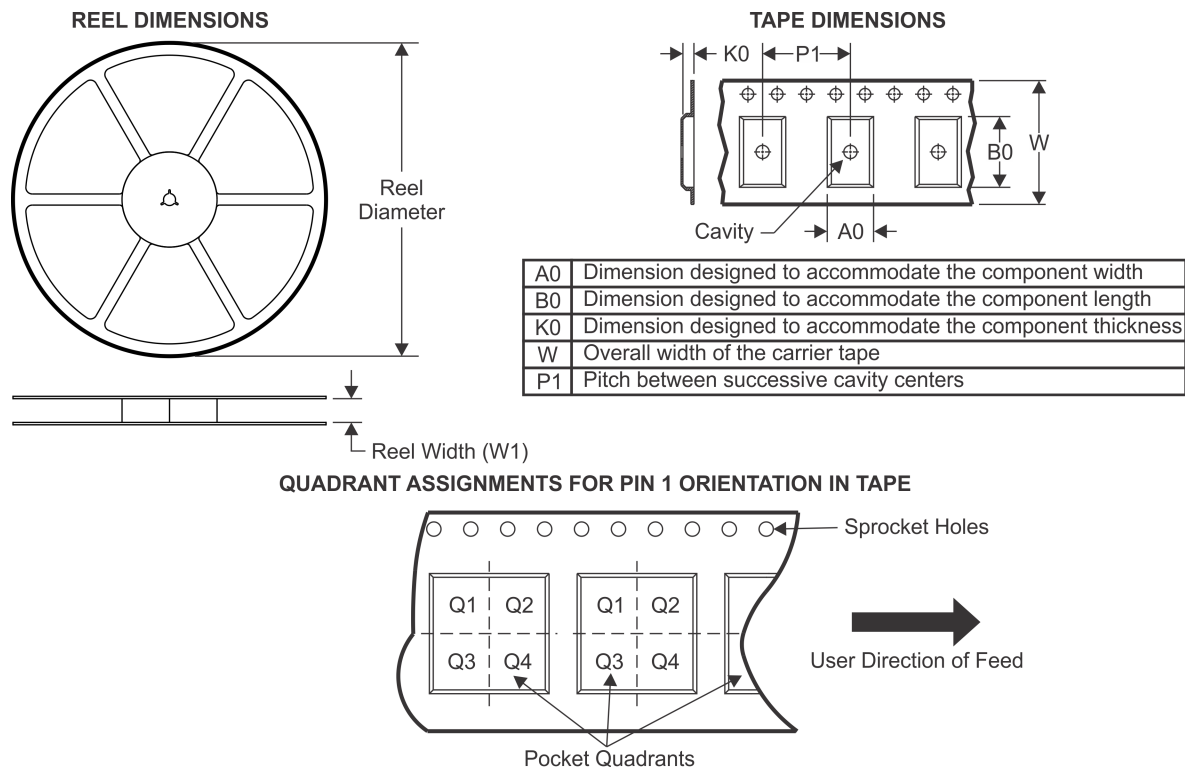
Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) Only one of markings shown within the brackets will appear on the physical device.

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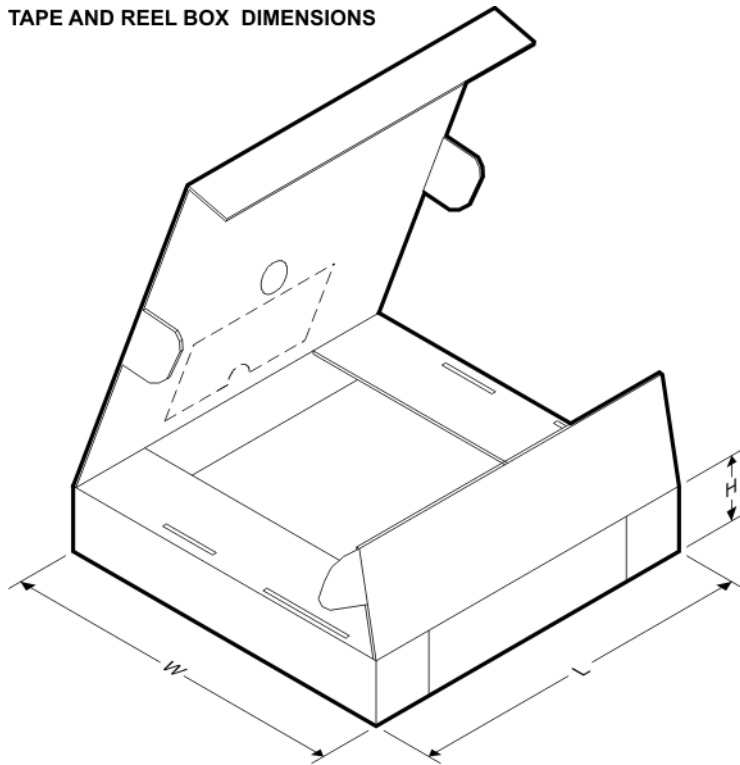
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TAPE AND REEL INFORMATION


*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
OPA4243EA/250	TSSOP	PW	14	250	180.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1
OPA4243EA/2K5	TSSOP	PW	14	2500	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1

TAPE AND REEL BOX DIMENSIONS



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
OPA4243EA/250	TSSOP	PW	14	250	210.0	185.0	35.0
OPA4243EA/2K5	TSSOP	PW	14	2500	367.0	367.0	35.0

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